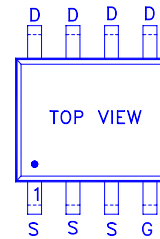
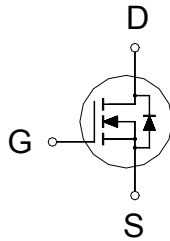


PRODUCT SUMMARY

$V_{(BR)DSS}$	$R_{DS(ON)}$	I_D
25V	70m Ω	1.2A



4 :GATE
5,6,7,8 :DRAIN
1,2,3 :SOURCE

ABSOLUTE MAXIMUM RATINGS ($T_C = 25\text{ }^\circ\text{C}$ Unless Otherwise Noted)

PARAMETERS/TEST CONDITIONS	SYMBOL	LIMITS	UNITS
Gate-Source Voltage	V_{GS}	± 15	V
Continuous Drain Current	I_D	$T_C = 25\text{ }^\circ\text{C}$	1.2
		$T_C = 100\text{ }^\circ\text{C}$	1.0
Pulsed Drain Current ¹	I_{DM}	12	A
Power Dissipation	P_D	$T_C = 25\text{ }^\circ\text{C}$	0.6
		$T_C = 100\text{ }^\circ\text{C}$	0.5
Operating Junction & Storage Temperature Range	T_j, T_{stg}	-55 to 150	$^\circ\text{C}$
Lead Temperature (¹ / ₁₆ " from case for 10 sec.)	T_L	275	

THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE	SYMBOL	TYPICAL	MAXIMUM	UNITS
Junction-to-Case	$R_{\theta JC}$		65	$^\circ\text{C} / \text{W}$
Junction-to-Ambient	$R_{\theta JA}$		230	

¹Pulse width limited by maximum junction temperature.

ELECTRICAL CHARACTERISTICS ($T_C = 25\text{ }^\circ\text{C}$, Unless Otherwise Noted)

PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNIT
			MIN	TYP	MAX	
STATIC						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = 250\text{ }\mu\text{A}$	25			V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\text{ }\mu\text{A}$	0.7	1.0	2.5	
Gate-Body Leakage	I_{GSS}	$V_{DS} = 0V, V_{GS} = \pm 15V$			± 250	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 20V, V_{GS} = 0V$			25	μA
		$V_{DS} = 20V, V_{GS} = 0V, T_J = 125\text{ }^\circ\text{C}$			250	
On-State Drain Current ¹	$I_{D(ON)}$	$V_{DS} = 10V, V_{GS} = 10V$	1.2			A
Drain-Source On-State Resistance ¹	$R_{DS(ON)}$	$V_{GS} = 7V, I_D = 1.2A$		120	180	m Ω
		$V_{GS} = 10V, I_D = 1.2A$		70	120	
Forward Transconductance ¹	g_{fs}	$V_{DS} = 20V, I_D = 1.2A$		16		S

DYNAMIC						
Input Capacitance	C_{iss}	$V_{GS} = 0V, V_{DS} = 15V, f = 1MHz$		120	pF	
Output Capacitance	C_{oss}			100		
Reverse Transfer Capacitance	C_{rss}			85		
Total Gate Charge ²	Q_g	$V_{DS} = 0.5V_{(BR)DSS}, V_{GS} = 10V, I_D = 1A$		11	nC	
Gate-Source Charge ²	Q_{gs}			3.0		
Gate-Drain Charge ²	Q_{gd}			5.8		
Turn-On Delay Time ²	$t_{d(on)}$	$V_{DS} = 15V, R_L = 1\Omega, I_D \cong 1A, V_{GS} = 10V, R_{GS} = 50\Omega$		7	nS	
Rise Time ²	t_r			20		
Turn-Off Delay Time ²	$t_{d(off)}$			13		
Fall Time ²	t_f			19		
SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS ($T_c = 25\text{ }^\circ\text{C}$)						
Continuous Current	I_S			1.2	A	
Pulsed Current ³	I_{SM}			12		
Forward Voltage ¹	V_{SD}	$I_F = I_S, V_{GS} = 0V$			1.3	V
Reverse Recovery Time	t_{rr}	$I_F = I_S, di_F/dt = 100A / \mu S$		70	nS	
Reverse Recovery Charge	Q_{rr}			0.22	μC	

¹Pulse test : Pulse Width $\leq 300\ \mu\text{sec}$, Duty Cycle $\leq 2\%$.

²Independent of operating temperature.

³Pulse width limited by maximum junction temperature.

REMARK: THE PRODUCT MARKED WITH "102B"

J-LEAD8 MECHANICAL DATA

Dimension	mm			Dimension	mm		
	Min.	Typ.	Max.		Min.	Typ.	Max.
A		0.50		H	0.10		0.20
B	0.15		0.3	I		0.048	
C	1.65		1.85	J	0		0.1
D	2.00	2.20	2.40	K	0.35	0.45	0.55
E	1.80	2.00	2.20	L	1.80	2.10	2.40
F	0.70	0.90	1.00	M			
G			1.10	N			

